L Number	Hits	Search Text	DB	Time stamp
10	90	(low near solder) and (high near solder)	USPAT;	2002/11/13 12:56
		and substrate	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
11	0	6344234.URPN.	USPAT	2002/11/13 11:50
12	0	6344234.URPN.	USPAT	2002/11/13 11:50
13	12	("3458925" "3512051" "4536421"	USPAT	2002/11/13 11:50
		"4673772" "4739917" "4830723"		
		"4950623" "4967950" "5075965"		
1 1 1	20	"5130779" "5154341" "5251806").PN.		
14	39 30	5251806.URPN.	USPAT	2002/11/13 11:54
16	30	5641113.URPN. 5641113.URPN.	USPAT	2002/11/13 12:00
17	30	5641113.URPN.	USPAT	2002/11/13 12:02
20	17	438/690.ccls.and solder	USPAT USPAT;	2002/11/13 12:04
20	1	1 4307 030.cc13.and 301del	US-PGPUB;	2002/11/13 12:31
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
21	179	abrad\$3 same solder	USPAT;	2002/11/13 12:52
			US-PGPUB;	2002/11/10 12:02
			EPO; JPO;	1
			DERWENT;	
			IBM TDB	1
22	3	((low near point) and (high near point))	USPAT;	2002/11/13 12:54
		and (barrier near solder)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	1.0	550 50 50 WD WY	IBM_TDB	
23	10	5536362.URPN.	USPAT	2002/11/13 12:55
24	2	(low near solder) and (high near solder) and (solder near barrier)	USPAT;	2002/11/13 13:02
		and (solder hear barrier)	US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM TDB	
25	1	((low near solder) and (high near solder))	USPAT;	2002/11/13 13:03
		same barrier	US-PGPUB;	2002/11/13 13:03
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
26	1	("4679772").PN.	USPAT	2002/11/13 13:03
27	1	("4673772").PN.	USPAT	2002/11/13 13:04
28	61	ball near barrier	USPAT	2002/11/13 13:05
29	121	solder near barrier	USPAT	2002/11/13 13:05
30	1	(ball near barrier) and (solder near	USPAT	2002/11/13 13:05
		barrier)		1
31	181	(ball near barrier) or (solder near	USPAT	2002/11/13 13:06
20	110	barrier)	II CDA M	2002/11/12 12-10
32	112	((ball near barrier) or (solder near barrier)) and (substrate or chip or die)	USPAT	2002/11/13 13:10
33	245955	dual solder	USPAT	2002/11/13 13:11
34	16	dual adj solder	USPAT	2002/11/13 13:11
35	0	257/780.ccls. and barrer	USPAT	2002/11/13 13:13
36	91	257/780.ccls. and barrier	USPAT	2002/11/13 13:14
		The second secon		